Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1 .	10	(US-20010036711-\$ or US-20020132463-\$ or US-20020158318-\$ or US-20030071350-\$ or US-20030128080-\$).did. or (US-5729435-\$ or US-5983974-\$ or US-6100593-\$ or US-6140144-\$ or US-6764881-\$).did.	US-PGPUB; USPAT	OR	ON	2007/04/18 13:05
L2	26012	anisotropic near5 (paste film adhesive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2007/04/18 13:05
L3	8	1 and L2	US-PGPUB; USPAT	OR	ON	2007/04/18 13:05
L4	20522	mcm ("multichip module")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:22
L5	36633	flip adj chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:22
L6	230	L5 and L4 and L2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:22
L7	81	L6 and cavity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:54
L8	2	6 and gas adj atmosphere	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:57

L9	27409	(257/678,684-687,690-693,698,700, 701,703-707,723-725,728,778, 787-789,795).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 14:57
L10	12621	(438/106-110,118-127).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 14:57
L11	37189	L9 L10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:57
L12	281	L11 and gas adj atmosphere	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 15:39
L13	9	12 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:58
L14	0	6 and planar adj antenna	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 15:39
L15	7	11 and planar adj antenna	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 15:39
S1	1279	((Heyen near (Johann J)) (Jacob near (Arne A))).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/02 11:54

S2	376209	"257".clas.	US-PGPUB;	OR	ON	2007/03/02 11:54
			USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB			
S3	11	S1 and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/02 12:58
S4	6	(("5650592") or ("5570502") or ("5526867")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 08:47
S5	2	("5983974").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 08:49
S6	2	"20030128080"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 09:21
S7	0	WO-199914806-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 09:22
S8	2	WO-9914806-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 09:59
S9	27409	(257/678,684-687,690-693,698,700, 701,703-707,723-725,728,778, 787-789,795).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 10:01

010	48684	(420/406 440 440 427) 6216	110 505115	00	055	2007/04/40 40 04
S10	12621	(438/106-110,118-127).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 10:01
S11	37189	S9 S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:02
S12	2218	Itcc ("low temperature cofired ceramic")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:03
S13	20522	mcm ("multichip module")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:03
S14	26012	anisotropic near5 (paste film adhesive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON ·	2007/04/18 10:04
S15	1	S11 and S12 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:44
S16	36633	flip adj chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:06
S17	0	S12 and S13 and S14 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:53

S18	9	S12 and S14 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:45
S19	4	S12 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:54
S20	230	S16 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:54